Features



3A Ultra Low Dropout Linear Regulator

General Description

The uP7701 is a 3A ultra low dropout linear regulator specifically designed for motherboard,notebook and graphic card applications. This device works with dual supplies, a control input for the control circuitry and a power input as low as 1.0V for providing current to output. The uP7701 delivers high-current and ultra-low-drop output voltage as low as 0.8V for applications where $\rm V_{\rm OUT}$ is very close to $\rm V_{\rm IN}$.

The uP7701 features comprehensive control and protection functions: a power on reset (POR) circuit for monitoring both control and power inputs for proper operation; an EN input for enabling or disabling the device, a power OK with time delay for indicating the output voltage status, a foldback current limit function, and a thermal shutdown function

The uP7701 is available in PSOP-8 package with very low thermal resistance.

Applications

- Desktop PCs, Notebooks, and Workstations
- Graphic Cards
- Low Voltage Logic Supplies
- Microprocessor and Chipset Supplies
- Split Plane Microprocessor Supplies
- Advanced Graphics Cards Supplies
- SoundCards and Auxiliary Power Supplies
- SMPS Post Regulators

☐ Works with 1.0V~5.5V V_{IN}

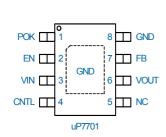
- Adjustable Output Voltage, Down to 0.8V
- 1.5% Initial Accuracy
- Excellent Line and Load Regulation
- 3A Guaranteed Output Current
 - 300mV @ 3A Dropout Voltage
- Very Low On-Resistance
 - 100mΩ typical
- V_{OUT} Pull Low Resistance when Disabled
- Low Reverse Leakage (Output to Input)
- V_{OUT} Power OK Signal
- Fast Transient Response
- Low External Component Count
- Low Cost and Easy to Use
- Enable Pin
- Over Current and Over Temperature Protection

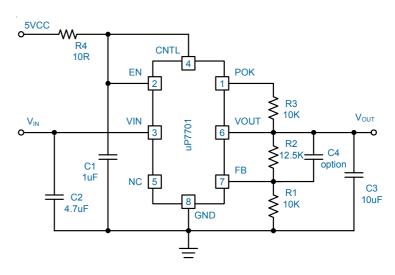
Ordering Information

Order Number	Package Type	Remark
uP7701U8	PSOP-8	

Note: uPI products are compatible with the current IPC/ JEDEC J-STD-020 and RoHS requirements. They are 100% matte tin (Sn) plating and suitable for use in SnPb or Pbfree soldering processes.

Pin Configuration & Typical Application Circuit



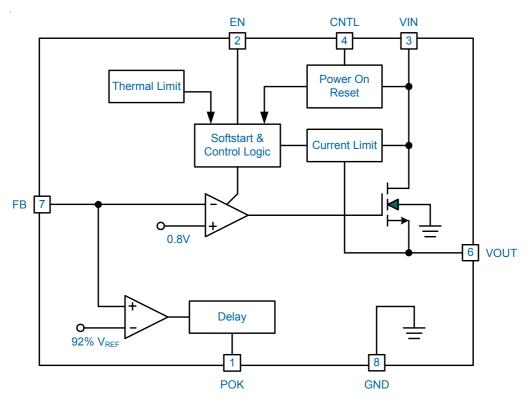




Functional Pin Description

Pin No.	Name	Pin Function
1	POK	Power OK Indication. This pin is an open-drain output and is set high impedance once V_{OUT} reaches 92% of its rating voltage.
2	EN	Enable Input. Pulling this pin below 0.4V turns the regulator off, reducing the quiescent current to a fraction of its operating value.
3	VIN	Input Voltage. This is the drain input to the power device that supply current to the output pin. Large bulk capacitors with low ESR should be placed physically close to this pin o prevent the input rail from dropping during large load transient. A 4.7uF ceramic capacitor is recommended at this pin. $V_{\mathbb{N}}$ cannot be forced higher than $V_{\mathbb{CNTL}}$ otherwise the current limit function may be false triggered and disable the output voltage.
4	CNTL	Supply Input for Control Circuit. This pin provides bias voltage to the control circuitry and driver for the pass transistor. The driving capability of output current is proportioned to the V_{CNTL} . For the device to regulate, the voltage on this pin must be at least 1.5V greater than the output voltage, and no less than V_{CNTL_MIN} .
5	NC	Not Internally Connected
6	VOUT	Output Voltage. This pin is power output of the device. A pull low resistance exists when the device is disabled by pulling low the EN pin. To maintain adequate transient response to large load change, typical value of 1000uF AI electrolytic capacitor with 10uF ceramic capacitors are recommended to reduce the effects of current transients on VOUT.
7	FB	Feedback Voltage. This pin is the inverting input to the error amplifier. A resistor divider from the output to GND is used to set the regulation voltage as $V_{OUT} = 0.8x(R1+R2)/R1$ (V)
8	GND	Ground.
Exposed Pad	GND	Ground. The exposed pad acts the dominant power dissipation path and should be soldered to well design PCB pads as described in the <i>Application Informations Chapter</i> .

Functional Block Diagram





Functional Description

Definitions

Some important terminologies for LDO are specified below.

Dropout Voltage

The input/output voltage differential at which the regulator output no longer maintains regulation against further reductions in input voltage. Measured when the output drops 2% below its nominal value. Dropout voltage is affected by junction temperature, load current and minimum input supply requirements.

Line Regulation

The change in output voltage for a change in input voltage. The measurement is made under conditions of low dissipation or by using pulse techniques such that average chip temperature is not significantly affected.

Load Regulation

The change in output voltage for a change in load current at constant chip temperature. The measurement is made under conditions of low dissipation or by using pulse techniques such that average chip temperature is not significantly affected.

Maximum Power Dissipation

The maximum total device dissipation for which the regulator will operate within specifications.

Quiescent Bias Current

Current which is used to operate the regulator chip and is not delivered to the load.

The quiescent current I_Q is defined as the supply current used by the regulator itself that does not pass into the load. It typically includes all bias currents required by the LDO and any drive current for the pass transistor.

Initialization

The uP7701 automatically initiates upon the receipt of supply voltage and power voltage. A power on reset circuit continuously monitors VIN and CNTL pins voltages with rising threshold levels of 0.6V and 2.7V respectively.

Chip Enable and Soft Start

The uP7701 features an enable pin for enable/disable control of the chip. Pulling $\rm V_{EN}$ lower than 0.8V disables the chip and reduces its quiescent current down to 12uA. When disabled, an internal MOSFET of $90\Omega~R_{\rm DS(ON)}$ turns on to pull output voltage to ground. Pulling $\rm V_{EN}$ higher than 1.6V enables the output voltage, providing POR is recognized. The uP7701 features soft start function that limits inrush current for charging the output capacitors. The soft start time is typically 5ms.

Output Voltage Programming

Figure 1 shows a typical application of 2.5V to 1.8V conversion with a 5.0V control supply. The output voltage is sensed through a voltage divider and regulated to internal reference voltage V_{REF} . The output voltage is programmed as:

$$V_{OUT} = V_{REF} \times (R_1 + R_2) / R_1 = 0.8V \times (22.5k/10k) = 1.8V$$

It's recommended to maintain 50-100uA through the output divider network for a tight load and line regulation. The internal voltage reference is $V_{\rm REF} = 0.8V$ with 1.5% initial accuracy. This commands the use of 0.5% or better accuracy resistors to build a precision power supply.

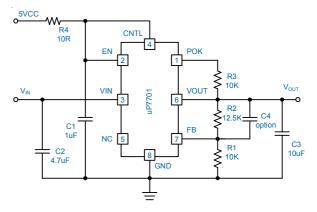


Figure 1. Typical application of 2.5V to 1.8V conversion with a 5.0V control supply

Over Current Protection

The uP7701 features a foldback over current protection function as shown in Figure 2. The current limit threshold level is proportinal to $V_{\text{OUT}}/V_{\text{NOM}}$ and is typically 4A when $V_{\text{OUT}} = V_{\text{NOM}}$, where V_{NOM} is the target output voltage. If the output continuously demands more current than the maximum current, output voltage will eventually drops below its nominal value. This, in turns, will lower its OCP threshold level. This will limit power dissipation in the device when over current limit happens. The power dissipation is near zero when the output is short circuited to ground.

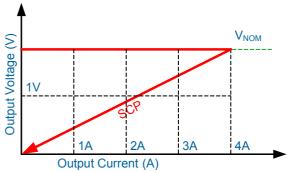


Figure 2. Current Limit Behavior



		Absolu	ute Ma	axım	um R	ating
Control Input Voltage V	(Note 1)				0.3	∨ to +6\
Power Input Voltage V _{IN}					0.3	V to +6\
Other Pins				-0.3V	to (V _{CNTL}	+ 0.3V
_ead Temperature (Solde	ering, 10 sec	:)				- 260°C
ESD Rating (Note 2)						
,	,					
MM (Machine Mode	e)					200\
			Therm	nal Ir	nform	atior
Package Thermal Resis						
PSOP-8 θ _{JA}						52°C/V
						15°C/V
Power Dissipation, P _D @						
PSOP-8						1.90
		Recommended O)perati	ion (Condi	tions
On anation dispetion Tana	t D.		-			
		ange (Note 4)				
		ange				
7					+4.5V	(C.C+ OJ
Supply Input Voltage, V _{CN}	ITL				±1.0\	/+o\/
Supply Input Voltage, V_{CN} Power Input Voltage, V_{IN}	VTL				+1.0V	to V _{CNT}
Supply Input Voltage, V _{cN} Power Input Voltage, V _{IN}	VTL	Elect			+1.0V	to V _{CNT}
Supply Input Voltage, V_{CN} Power Input Voltage, V_{IN} $(V_{CNTL} = 5V, T_A = 25^{\circ}C, u)$		Elect			+1.0V	to V _{CNT}
Power Input Voltage, V_{IN} $V_{CNTL} = 5V, T_A = 25^{\circ}C, uI$	nless other	Elect			+1.0V	to V _{CNT}
Power Input Voltage, V_{IN} $V_{CNTL} = 5V, T_A = 25^{\circ}C, uI$ Parameter	nless other	wise specified)	rical (Char	+1.0V acter i	to V _{CNTI}
Power Input Voltage, V _{IN}	nless otherv	wise specified)	rical (Char	+1.0V acter i	to V _{CNTI}
Power Input Voltage, V_{IN} $V_{CNTL} = 5V$, $T_A = 25^{\circ}C$, un Parameter Supply Input Voltage	Symbol	wise specified) Test Conditions	Min	Char	acteri	to V _{CNT}
Power Input Voltage, V _{IN} (V _{CNTL} = 5V, T _A = 25°C, un Parameter Supply Input Voltage Control Input Voltage	Symbol V _{CNTL} V _{CNTLRTH}	wise specified) Test Conditions	Min 3.0	Typ	+1.0V acteri Max	to V _{CNT}
Power Input Voltage, V _{IN} (V _{CNTL} = 5V, T _A = 25°C, unit of the second of the seco	Symbol	wise specified) Test Conditions	Min 3.0	Тур 2.7	+1.0V acterion Max 5.5 2.9	v to V _{CNT}
Power Input Voltage, V _{IN} V _{CNTL} = 5V, T _A = 25°C, un Parameter Supply Input Voltage Control Input Voltage POR Threshold POR Hysteresis	Symbol V _{CNTL} V _{CNTLRTH} V _{CNTLHYS}	wise specified) Test Conditions V _{OUT} = V _{REF}	Min 3.0	Typ 2.7 0.2	+1.0V acterion Max 5.5	v to V _{CNT} v to V _{CNT} v to V _{CNT} v to V _{CNT} v v
Power Input Voltage, V _{IN} V _{CNTL} = 5V, T _A = 25°C, un Parameter Supply Input Voltage Control Input Voltage POR Threshold POR Hysteresis Power Input Voltage Control Input Voltage	Symbol V _{CNTL} V _{CNTLRTH} V _{CNTLHYS} V _N	wise specified) Test Conditions $V_{\text{OUT}} = V_{\text{REF}}$ $V_{\text{OUT}} = V_{\text{REF}}$	Min 3.0 1.0	Typ 2.7 0.2	+1.0V acteri Max 5.5 2.9 V _{CNTL}	v to V _{CNT} v to V _{CNT} v to V _{CNT} v v v v
Power Input Voltage, V _{IN} V _{CNTL} = 5V, T _A = 25°C, un Parameter Supply Input Voltage Control Input Voltage POR Threshold POR Hysteresis Power Input Voltage Control Input Voltage Control Input Voltage Control Input Voltage	Symbol V _{CNTL} V _{CNTLRTH} V _{CNTLHYS} V _N	wise specified) Test Conditions $V_{OUT} = V_{REF}$ $V_{OUT} = V_{REF}$ $V_{CNTL} = V_{IN} = 5.0V, I_{OUT} = 0A, V_{EN} = 0V$	Min 3.0 1.0	Typ 2.7 0.2 20	+1.0V acteria Max 5.5 2.9 V _{CNTL} 40	V to V _{CNT} Units Units V V V UA
Power Input Voltage, V _{IN} V _{CNTL} = 5V, T _A = 25°C, un Parameter Supply Input Voltage Control Input Voltage POR Threshold POR Hysteresis Power Input Voltage Control Input Current in Shutdown Control Input Current Quiescent Current	Symbol V _{CNTL} V _{CNTLRTH} V _{CNTLHYS} V _{IN} I _{CNTL_SD}	wise specified) Test Conditions $V_{\text{OUT}} = V_{\text{REF}}$ $V_{\text{OUT}} = V_{\text{REF}}$ $V_{\text{CNTL}} = V_{\text{IN}} = 5.0 \text{V}, \ I_{\text{OUT}} = 0 \text{A}, \ V_{\text{EN}} = 0 \text{V}$ $V_{\text{CNTL}} = V_{\text{IN}} = V_{\text{EN}} = 5.0 \text{V}, \ I_{\text{OUT}} = 0 \text{A}, \ V_{\text{OUT}} = V_{\text{REF}}$	Min 3.0 1.0 1.0	Typ 2.7 0.2 20 1.0	+1.0V acteria Max 5.5 2.9 V_CNITL 40 1.5	V to V _{CNT} Units V V V V UA MA
Power Input Voltage, V _{IN} V _{CNTL} = 5V, T _A = 25°C, un Parameter Supply Input Voltage Control Input Voltage POR Threshold POR Hysteresis Power Input Voltage Control Input Current in Shutdown Control Input Current Quiescent Current Feedback Voltage	Symbol V _{CNTL} V _{CNTLRTH} V _{CNTLHYS} V _{IN} I _{CNTL_SD}	wise specified) Test Conditions $V_{\text{OUT}} = V_{\text{REF}}$ $V_{\text{OUT}} = V_{\text{REF}}$ $V_{\text{CNTL}} = V_{\text{IN}} = 5.0 \text{V}, \ I_{\text{OUT}} = 0 \text{A}, \ V_{\text{EN}} = 0 \text{V}$ $V_{\text{CNTL}} = V_{\text{IN}} = V_{\text{EN}} = 5.0 \text{V}, \ I_{\text{OUT}} = 0 \text{A}, \ V_{\text{OUT}} = V_{\text{REF}}$	Min 3.0 1.0 1.0	Typ 2.7 0.2 20 1.0	+1.0V acteria Max 5.5 2.9 V_CNITL 40 1.5	V to V _{CNT} Units Units V V V UA MA
Power Input Voltage, V _{IN} V _{CNTL} = 5V, T _A = 25°C, un Parameter Supply Input Voltage Control Input Voltage POR Threshold POR Hysteresis Power Input Voltage Control Input Current in Shutdown Control Input Current Quiescent Current Feedback Voltage Reference Voltage	Symbol V _{CNTL} V _{CNTLRTH} V _{CNTLHYS} V _N I _{CNTL_SD} I _{CNTL} I _Q	wise specified) Test Conditions $V_{\text{OUT}} = V_{\text{REF}}$ $V_{\text{OUT}} = V_{\text{REF}}$ $V_{\text{CNTL}} = V_{\text{IN}} = 5.0 \text{V}, \ I_{\text{OUT}} = 0 \text{A}, \ V_{\text{EN}} = 0 \text{V}$ $V_{\text{CNTL}} = V_{\text{IN}} = V_{\text{EN}} = 5.0 \text{V}, \ I_{\text{OUT}} = 0 \text{A}, \ V_{\text{OUT}} = V_{\text{REF}}$ $V_{\text{CNTL}} = V_{\text{IN}} = V_{\text{EN}} = 5.0 \text{V}, \ I_{\text{OUT}} = 0 \text{A}, \ V_{\text{OUT}} = V_{\text{REF}}$	Min 3.0 1.0 1.0	Typ 2.7 0.2 20 1.0 1.0	+1.0V acteria Max 5.5 2.9 V_CNITL 40 1.5 1.5	V to V _{CNT} Units Units V V V UA MA MA
Power Input Voltage, V _{IN} V _{CNTL} = 5V, T _A = 25°C, un Parameter Supply Input Voltage Control Input Voltage POR Threshold POR Hysteresis Power Input Voltage Control Input Current in Shutdown Control Input Current Quiescent Current Feedback Voltage Reference Voltage Feedback Input Current	Symbol V _{CNTL} V _{CNTLRTH} V _{CNTLRTH} V _{CNTLLSD} I _{CNTL} I _Q V _{REF}	wise specified) Test Conditions $V_{\text{OUT}} = V_{\text{REF}}$ $V_{\text{OUT}} = V_{\text{REF}}$ $V_{\text{CNTL}} = V_{\text{IN}} = 5.0 \text{V}, \ I_{\text{OUT}} = 0 \text{A}, \ V_{\text{EN}} = 0 \text{V}$ $V_{\text{CNTL}} = V_{\text{IN}} = V_{\text{EN}} = 5.0 \text{V}, \ I_{\text{OUT}} = 0 \text{A}, \ V_{\text{OUT}} = V_{\text{REF}}$ $V_{\text{CNTL}} = V_{\text{IN}} = V_{\text{EN}} = 5.0 \text{V}, \ I_{\text{OUT}} = 0 \text{A}, \ V_{\text{OUT}} = V_{\text{REF}}$ $V_{\text{CNTL}} = V_{\text{IN}} = V_{\text{EN}} = 5.0 \text{V}, \ I_{\text{OUT}} = 0 \text{A}, \ V_{\text{OUT}} = V_{\text{REF}}$	Min 3.0 1.0 0.788	Typ 2.7 0.2 20 1.0 1.0	+1.0V acteria Max 5.5 2.9 V_CNITL 40 1.5 1.5	V to V _{CNT} Units Units V V V UA MA MA
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Power Input Voltage, V _{IN} V _{CNTL} = 5V, T _A = 25°C, un Parameter Supply Input Voltage Control Input Voltage POR Threshold POR Hysteresis Power Input Voltage Control Input Current in Shutdown Control Input Current	Symbol V _{CNTL} V _{CNTLRTH} V _{CNTLRTH} V _{CNTLLYS} V _N I _{CNTL_SD} I _Q V _{REF} I _{FB} V _{REF(LINE)}	wise specified) Test Conditions $V_{\text{OUT}} = V_{\text{REF}}$ $V_{\text{OUT}} = V_{\text{REF}}$ $V_{\text{CNTL}} = V_{\text{IN}} = 5.0 \text{V, } I_{\text{OUT}} = 0 \text{A, } V_{\text{EN}} = 0 \text{V}$ $V_{\text{CNTL}} = V_{\text{IN}} = V_{\text{EN}} = 5.0 \text{V, } I_{\text{OUT}} = 0 \text{A, } V_{\text{OUT}} = V_{\text{REF}}$ $V_{\text{CNTL}} = V_{\text{IN}} = V_{\text{EN}} = 5.0 \text{V, } I_{\text{OUT}} = 0 \text{A, } V_{\text{OUT}} = V_{\text{REF}}$ $V_{\text{CNTL}} = V_{\text{IN}} = V_{\text{EN}} = 5.0 \text{V, } I_{\text{OUT}} = 0 \text{A, } V_{\text{OUT}} = V_{\text{REF}}$ $1.0 \text{V} < V_{\text{IN}} < 5.0 \text{V, } V_{\text{CNTL}} = V_{\text{EN}} = 5.0 \text{V, } I_{\text{OUT}} = 0 \text{A. } V_{\text{OUT}} = 0 \text{A. } V_{\text{OUT}} = V_{\text{REF}}$	Min 3.0 1.0 0.788	Typ 2.7 0.2 20 1.0 1.0 0.8 20 0.1	+1.0V acterial Max 5.5 2.9 V_CNTL 40 1.5 1.5 0.812 0.3	V V V V V V V V V V V V V V V V V V V



Electrical Characteristics

Parameter	Symbol	Test Conditions	Min	Тур	Max	Units	
Feedback Voltage (V _{REFIN} = V _{CNTL)}							
On Resistance	R _{DS(ON)}	I _{OUT} = 100mA, V _{CNTL} = V _{EN} = 5.0V, V _{OUT} = 1.6V		100	120	mΩ	
Dropout Voltage	V _{DROP}	$I_{OUT} = 2A, V_{CNTL} = V_{EN} = 5.0V, V_{OUT} = 1.6V, by design$		200	240	mV	
		$I_{OUT} = 3A$, $V_{CNTL} = V_{EN} = 5.0V$, $V_{OUT} = 1.6V$, by design		300	360	IIIV	
V _{OUT} Pull Low Resistance		$V_{CNTL} = V_{IN} = 5.0V$, $V_{EN} = 0V$, by design		90		Ω	
Enable							
Enable High Level	V _{EN}				1.6	V	
Disable Low Level	V _{SD}		0.4			V	
EN Source Current	I _{EN}	V _{EN} = 0V, V _{CNTL} = 5.0V		12	20	uA	
EN Input Impedance	Z _{EN}			65		ΚΩ	
PWROK							
FB Power OK Threshold	V _{POKTH}	$I_{OUT} = 0A$, $V_{CNTL} = V_{IN} = V_{EN} = 5.0V$, $V_{OUT} = V_{REF}$		92		%	
Power OK Hysteresis	V _{POKHYS}	$I_{OUT} = 0A$, $V_{CNTL} = V_{IN} = V_{EN} = 5.0V$, $V_{OUT} = V_{REF}$		8		%	
POK Delay Time		From $V_{OUT} > 92\% V_{NOM}$ to POK rising		1		ms	
Overcurrent Protection							
OCP Threshold Level	I _{OCP}	$V_{CNTL} = V_{IN} = V_{EN} = 5.0V, V_{OUT} = V_{REF}$	3.5			Α	
Output Short Circuit Current	I _{sc}	$V_{CNTL} = V_{IN} = V_{EN} = 5.0V, V_{OUT} = 0V$	_	100	-	mA	
Thermal Protection							
Thermal Shutdown Temperature	T _{SD}	$I_{OUT} = 0A$, $V_{CNTL} = V_{IN} = V_{EN} = 5.0V$, $V_{OUT} = V_{REF}$		170	_	°C	
Thermal Shutdown Hysteresis	T _{SDHYS}	$I_{OUT} = 0A$, $V_{CNTL} = V_{IN} = V_{EN} = 5.0V$, $V_{OUT} = V_{REF}$		30		°C	

- **Note 1.** Stresses listed as the above "Absolute Maximum Ratings" may cause permanent damage to the device. These are for stress ratings. Functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may remain possibility to affect device reliability.
- **Note 2.** Devices are ESD sensitive. Handling precaution recommended.
- **Note 3.** θ_{JA} is measured in the natural convection at $T_A = 25^{\circ}\text{C}$ on a low effective thermal conductivity test board of JEDEC 51-3 thermal measurement standard.
- **Note 4.** The device is not guaranteed to function outside its operating conditions.

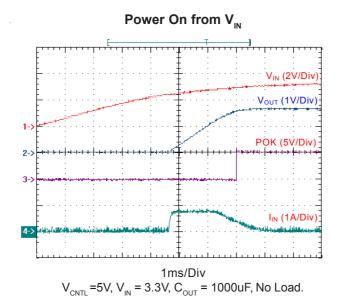
V_{OUT} (1V/Div)

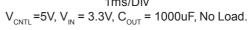
I_{IN} (1A/Div)



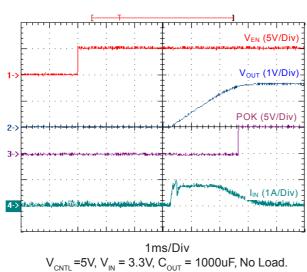
Typical Operation Characteristics

Power On from V_{CNTL}

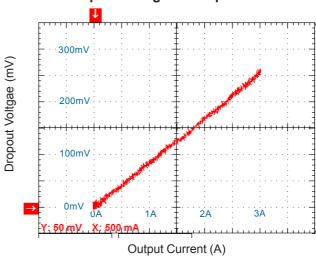


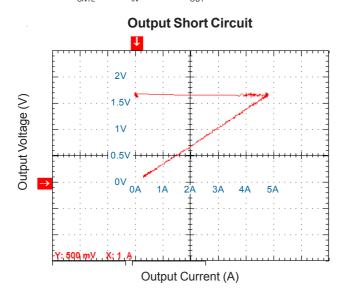


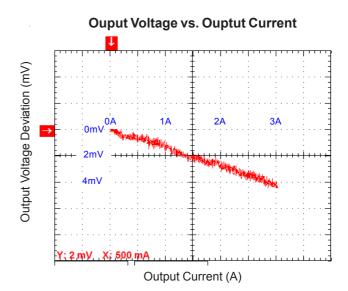
Turn On from EN





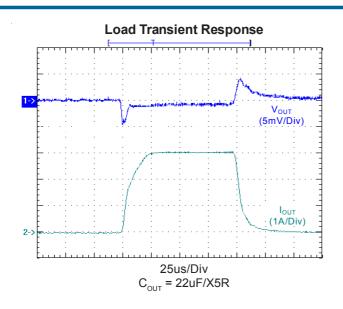


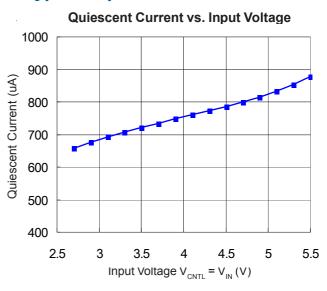


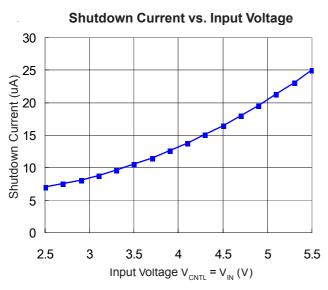


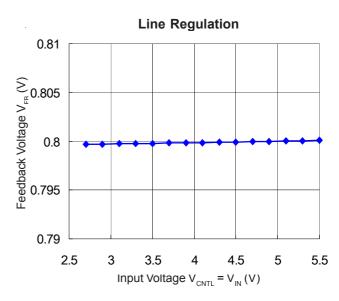


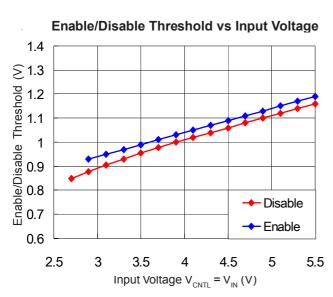
Typical Operation Characteristics

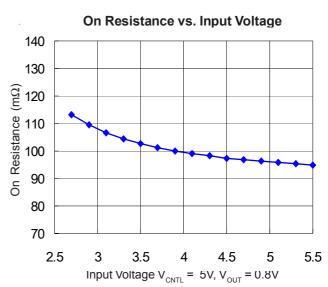






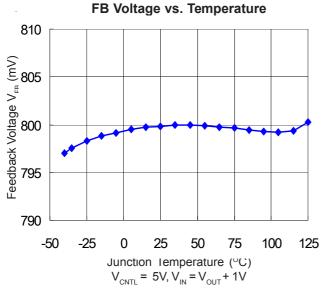


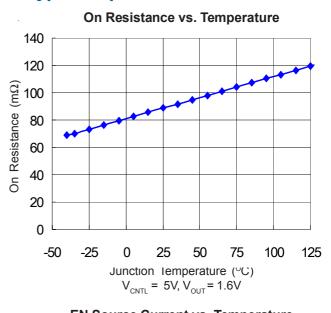


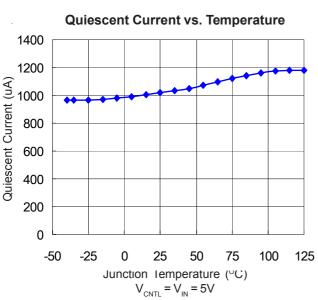


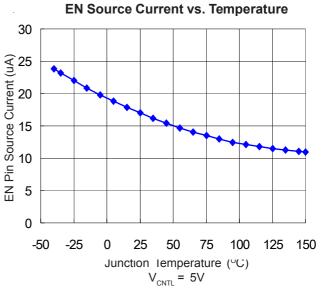


Typical Operation Characteristics











Application Information

The uP7701 is a high performance linear regulator specifically designed to deliver up to 3A output current with very low input voltage and ultra low dropout voltage. With dual-supply configuration, the uP7701 operates with a wide input voltage V_{IN} range from 1.0V to 5.5V and is ideal for applications where V_{OUT} is very close to V_{IN} .

Supply Voltage for Control Circuit V_{CNTI}

Unlike other linear regulators that use a P-Channel MOSFET as the pass transistor, the uP7701 uses an N-Channel as the pass transistor. N-Channel MOSFET provides lower on-resistance and better stability meeting stringent requirements of current generation microprocessors and other sensitive electronic devices. The drain of N-Channel MOSFET is connected to VIN and the source is connected to VOUT. This requires that the supply voltage $V_{\rm CNTL}$ for control circuit is at least 1.5V higher than the output voltage to provide enough overdrive capability for the pass transistor thus to achieve low dropout and fast transient response. It is highly recommended to bias the device with 5V voltage source if available.

Use a minimum 0.1uF ceramic capacitor plus a 10Ω resistor to locally bypass the control voltage.

Input/Output Capacitor Selection

The uP7701 has a fast transient response that allows it to handle large load changes associated with high current applications. Proper selection of the of the output capacitor and it's ESR value determines stable operation and optimizes performance. The typical application circuit shown in Figure 1 was tested with a wide range of different capacitors. The circuit was found to be unconditionally stable with capacitor values from 10uF to 2200uF and ESR ranging from $0.5 m\Omega$ to greater then $75 m\Omega$.

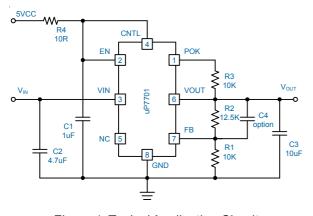


Figure 1. Typical Application Circuit

Input capacitor: A minimum of 4.7uF ceramic capacitor is recommended to be placed directly next to the VIN pin. This allows for the device being some distance from any

bulk capacitance on the rail. Additionally, bulk capacitance may be added closely to the input supply pin of the uP7701 to ensure that $V_{\rm IN}$ does not sag, improving load transient response.

Output capacitor: A minimum bulk capacitance of 10uF, along with a 0.1uF ceramic decoupling capacitor is recommended. Increasing the bulk capacitance will improve the overall transient response. The use of multiple lower value ceramic capacitors in parallel to achieve the desired bulk capacitance will not cause stability issues. Although designed for use with ceramic output capacitors, the uP7701 is extremely tolerant of output capacitor ESR values and thus will also work comfortably with tantalum output capacitors.

Thermal Consideration

The uP7701 integrates internal thermal limiting function to protect the device from damage during fault conditions. However, continuously keeping the junction near the thermal shutdown temperature may remain possibility to affect device reliability. It is highly recommended to keep the junction temperature below the recommended operation condition 125°C for maximum reliability.

Power dissipation in the device is calculated as:

$$P_{D} = (V_{IN} - V_{OUT}) \times I_{OUT} + V_{CNTL} \times I_{CNTL}$$

It is adequate to neglect power loss with respective to control circuit V_{CNTL} x I_{CNTL} when considering thermal management in uP7701 Take the following moderate operation condition as an example: V_{IN} = 2.5V, V_{OUT} = 1.5V, I_{OUT} = 2A, the power dissipation is:

$$P_D = (1.8V-1.2V) \times 2A = 2.0W$$

This power dissipation is conducted through the package into the ambient environment, and, in the process, the temperature of the die $(\mathsf{T}_{_{J}})$ rises above ambient. Large power dissipation may cause considerable temperature raise in the regulator in large dropout applications. The geometry of the package and of the printed circuit board (PCB) greatly influence how quickly the heat is transferred to the PCB and away from the chip. The most commonly used thermal metrics for IC packages are thermal resistance from the chip junction to the ambient air surrounding the package $(\theta_{_{JA}})$:

$$\theta_{JA} = (T_J - T_A) / P_D$$

 θ_{JA} specified in the *Thermal Information* section is measured in the natural convection at T_A = 25°C on a high effective thermal conductivity test board (4 Layers, 2S2P) of JEDEC 51-7 thermal measurement standard. The case point of θ_{JC} is on the exposed pad for PSOP-8 package.



Application Information

Given power dissipation P_D , ambient temperature and thermal resistance θ_{JA} , the junction temperature is calculated as:

$$T_J = T_A + \Delta T_{JA} = T_A + P_D \times \theta_{JA}$$

To limit the junction temperature within its maximum rating, the allowable maximum power dissipation is calculated as:

$$P_{D(MAX)} = (T_{J(MAX)} - T_A) / \theta_{JA}$$

where $T_{J(MAX)}$ is the maximum operation junction temperature 125°C, T_A is the ambient temperature and the θ_{JA} is the junction to ambient thermal resistance. θ_{JA} of PSOP-8 packages is 75°C/W on JEDEC 51-7 (4 layers, 2S2P) thermal test board with minimum copper area. The maximum power dissipation at T_A = 25°C can be calculated as:

$$P_{D(MAX)} = (125^{\circ}C - 25^{\circ}C) / 75^{\circ}C/W = 1.33W$$

The thermal resistance θ_{JA} highly depends on the PCB design. Copper plane under the exposed pad is an effective heatsink and is useful for improving thermal conductivity. Figure 3 show the relationship between thermal resistance θ_{JA} vs. copper area on a standard JEDEC 51-7 (4 layers, 2S2P) thermal test board at T_A = 25°C. A 50mm² copper plane reduces θ_{JA} from 75°C/W to 52°C/W and increases maximum power dissipation from 1.33W to 1.9W.

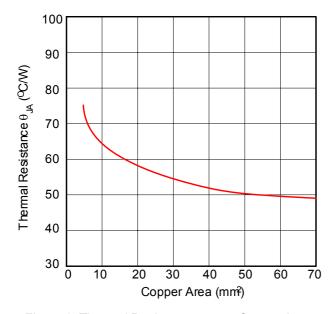


Figure 3. Thermal Resistance θ_{JA} vs. Copper Area Figure 4 illustrated the recommended PCB layout for best thermal performance.

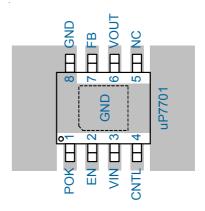


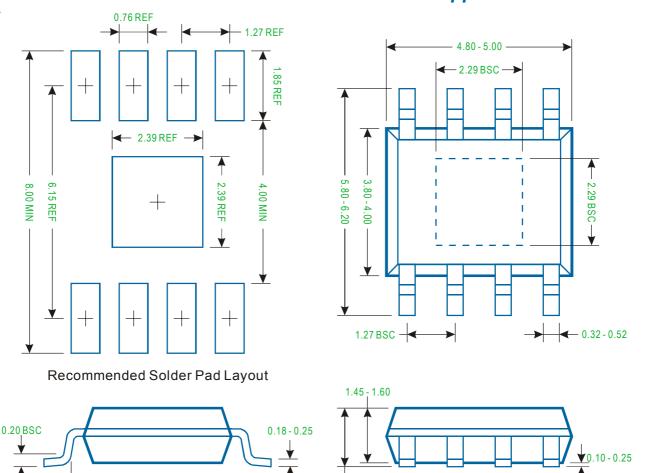
Figure 4. Recommended PCB Layout.

Layout Consideration

- Place a local bypass capacitor as closed as possible to the VIN pin. Use short and wide traces to minimize parasitic resistance and inductance.
- 2. The exposed pad should be soldered on GND plane with maximum area and with multiple vias to inner layer of ground place for improving thermal performance.
- Connect voltage divider directly to the point where regulation is required. Place voltage divider close to the device.



Application Information



1.75 MAX

Note

- 1. Package Outline Unit Description:
 - BSC: Basic. Represents theoretical exact dimension or dimension target
 - MIN: Minimum dimension specified.

0.41 - 0.89

- MAX: Maximum dimension specified.
- REF: Reference. Represents dimension for reference use only. This value is not a device specification.
- TYP. Typical. Provided as a general value. This value is not a device specification.
- 2. Dimensions in Millimeters.
- 3. Drawing not to scale.
- 4. These dimensions no not include mold flash or protrusions. Mold flash or protrusions shell not exceed 0.15mm.